

# Ferrotec Nord Corp.

## PRODUCT GENERAL SPECIFICATION

Last update: January 01, 2016

### TWO-STAGE STANDARD MODULES

MODULE TYPE	BASIC CHARACTERISTICS, Th=25 °C, VACUUM ENVIRONMENT				DIMENSIONS, mm		
	I <sub>max</sub> , A	U <sub>max</sub> , V	Q <sub>cmax</sub> , W	ΔT <sub>max</sub> , °C	Cold side	Hot side	Height
2TM-127-31-5.0	5.0	15.5	17	95	40 x 40	40 x 40	11.7
2TM-127-63-6.5	6.5	16.0	35	86	40 x 40	40 x 40	7.5

#### DESIGNATIONS:

I<sub>max</sub> – Input current resulting in greatest ΔT<sub>max</sub>, (A)

U<sub>max</sub> – Input Voltage at ΔT<sub>max</sub>, (V)

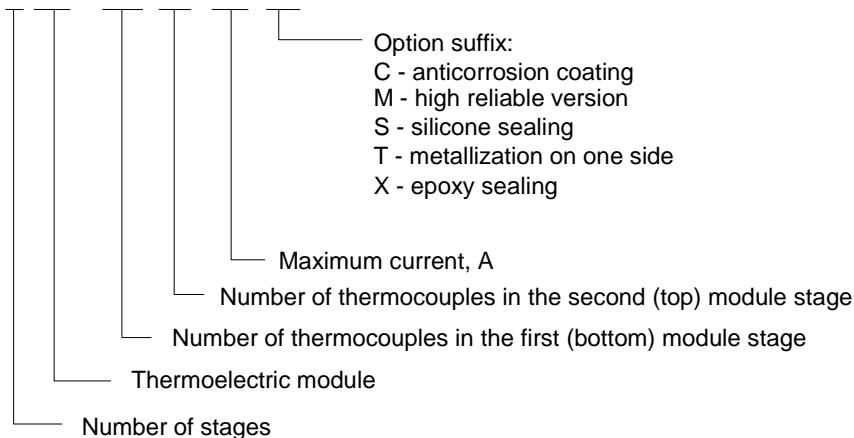
Q<sub>cmax</sub> – Maximum heat pumping capacity at I<sub>max</sub>, ΔT = 0 K, (W)

ΔT<sub>max</sub> – Maximum temperature difference a module can achieve at I = I<sub>max</sub> and Q<sub>c</sub> = 0, (K)

#### HOW TO DECODE PELTIER MODULE MARKING:

##### Two stage modules:

2TM-127-63-6.5 M



## POWER GENERATING MODULES

Module operating properties are given at hot side temperature 200 °C and cold side temperature 50 °C. Under these conditions maximum efficiency of electric power generation is around 3% for all presented modules.

Efficiency is determined as  $W_{load}/Q_{hot}$ , where  $W_{load}$  is an output power,  $Q$  is a heat flow through the module.

MODULE TYPE	Operating properties					DIMENSIONS, mm		
	U <sub>oc</sub> , V	R <sub>load</sub> Ohm	W <sub>load</sub> , W	U <sub>load</sub> V	Λ <sub>m</sub> , W/°C	Cold side	Hot side	Height
TMG-18-5.0-1.1	1.08	0.028	7.8	0.47	1.05	40 × 40	40 × 40	4.1
TMG-18-5.0-1.3	1.08	0.034	6.5	0.47	0.88	40 × 40	40 × 40	4.3
TMG-18-5.0-1.6	1.08	0.041	5.3	0.47	0.71	40 × 40	40 × 40	4.6
TMG-111-1.4-1.2 *	6.8	2.0	4.2	2.9	0.57	35 × 40	35 × 40	3.0
TMG-127-0.4-1.6 **	2.8	24	0.084	1.4	0.048	20 × 20	20 × 20	3.3
TMG-127-1.0-1.3	7.6	4.4	2.4	3.8	0.33	30 × 30	30 × 30	3.6
TMG-127-1.0-1.6	7.6	5.5	2.0	3.8	0.27	30 × 30	30 × 30	3.8
TMG-127-1.0-2.0	7.6	7.0	1.6	3.8	0.21	30 × 30	30 × 30	4.2
TMG-127-1.4-1.1	7.6	2.3	5.5	3.8	0.78	40 × 40	40 × 44	3.5
TMG-127-1.4-1.2	7.6	2.3	4.8	3.8	0.85	40 × 40	40 × 40	3.4
TMG-127-1.4-1.6	7.6	3.0	3.7	3.8	0.5	40 × 40	40 × 40	3.8
TMG-127-1.4-2.5	7.6	4.7	2.3	3.8	0.31	40 × 40	40 × 40	4.7
TMG-127-2.0-1.3	7.6	1.2	9.0	3.8	1.26	50 × 50	50 × 54	3.6
TMG-127-2.0-1.6	7.6	1.4	7.5	3.8	1.02	50 × 50	50 × 54	3.8
TMG-161-1.3-1.1	9.8	3.5	6.8	4.9	1.2	40 × 40	40 × 44	3.7
TMG-199-1.4-0.9	11.0	3.5	8.4	5.5	1.4	40 × 40	40 × 44	3.6
TMG-241-1.0-1.3	12.6	8.4	4.7	6.3	0.63	40 × 40	40 × 40	3.6
TMG-241-1.0-1.6	12.6	10.3	3.8	6.3	0.51	40 × 40	40 × 40	3.8
TMG-241-1.4-1.2	12.6	4.2	9.4	6.3	1.28	54.4 × 54.4	54.4 × 57	3.4
TMG-254-1.4-1.2	13.2	4.4	10.0	6.6	1.3	40 × 80	44 × 80	3.4
TMG-254-1.4-1.6	13.2	5.9	7.4	6.6	1.0	40 × 80	44 × 80	3.8
TMG-450-0.8-1.0	23.6	20.0	6.8	11.7	0.93	54.4 × 54.4	54.4 × 57.0	3.4

\* Module is assembled without top (hot) ceramic substrate (half skeleton).

\*\* Module operating properties are given at hot side temperature 70 °C and cold side temperature 20 °C.

### DESIGNATIONS:

U<sub>oc</sub> – open circuit voltage, (V)

R<sub>in</sub> – module internal resistance at 110 °C, (Ohm)

R<sub>load</sub> – matched load resistance, (Ohm)

U<sub>load</sub> – output voltage, (V), corresponded to matched load

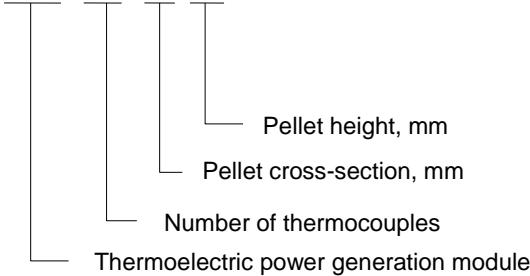
Λ<sub>m</sub> – module thermal conductance at 110 °C, (W/°C)

Notes:

1. The open circuit voltage  $U_{oc}$  is the output voltage of the module without any load.
2. The match load is the module load when the load resistance  $R_{load}$  equals to the module's internal resistance  $R_{in}$ .
3. The output voltage and power will change with the load. Under match load the output power is at maximum under specified cold and hot side temperatures.
4. To get the best efficiency, the module should be mounted between flat and lapped faces and uniformly pressed with the force 120-150 N/cm<sup>2</sup> of module cold side surface.

HOW TO DECODE POWER GENERATING MODULE MARKING:

TMG-127-1.0-2.0



GENERAL TECHNICAL DATA AND OPTIONS

1. Interior solders:

- Standard option – high temperature lead free solder with melting point temperature (mpt) higher 227 °C: Sn-Cu (mpt ≥ 227 °C), Sn-Cu-Ni (mpt = 227 °C), Sn-Sb (mpt = 232-240 °C),
- Special request - low temperature lead free solder Bi-Sn (mpt = 139 °C).

2. Outer ceramic surfaces can be

- Lapped
- Metallized
- Au plated
- Tinned by solders: In-Sn (mpt = 117 °C), In-Ag (mpt = 143 °C), Bi-Sn (mpt = 139 °C).

3. Lead wires:

- For standard modules – 18, 20, 22 or 24 AWG stranded tinned copper in PVC insulation, Teflon and Silicone insulation is available;
- For microcoolers – 30 AWG uninsulated solid wire.

4. All modules are assembled with multilayer antidiffusion barriers onto thermoelectric pellets.

5. Module height tolerance is ± 0.2 mm; height tolerance of 0.02 mm is available on request.

6. Flatness and parallel variance not more than 0.02 mm.

ADDITIONAL DATA

1. Reliability tests of modules are available upon customer request.
2. All modules are assembled in accordance with RoHS requirements.
3. All modules are subjected to both thermal cycling influence test and ultrasonic diagnostics.
4. Thermal screening for control of temperature uniformity is provided upon request

◆ SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.

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